



### General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

$BV_{DSS}$	$R_{DS(ON)}$	$I_D$
40 V	4 m $\Omega$	85 A

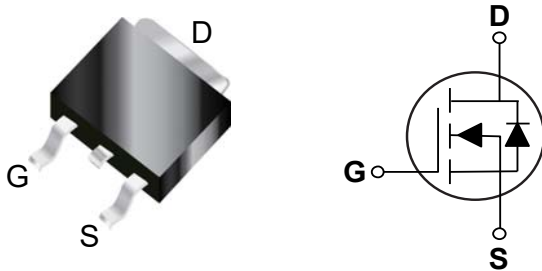
### Features

- $R_{DS(ON)} \leq 4m\Omega @ V_{GS}=10V$
- Fast Switching
- Green Device Available

TO-263 Pin Configuration

### Applications

- Synchronous Rectification
- DC/DC Converter



### Absolute Maximum Ratings $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	40	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current - Continuous ( $T_C=25^\circ\text{C}$ )	85	A
$I_{DM}$	Drain Current - Pulsed (NOTE 1)	340	A
EAS	Single Pulse Avalanche Energy (NOTE 2)	200	mJ
IAS	Single Pulse Avalanche Current (NOTE 2)	20	A
$P_D$	Power Dissipation ( $T_C=25^\circ\text{C}$ )	96.1	W
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
Marking Code		ND4P0	

### Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JC}$	Thermal Resistance Junction to Case	1.3	$^\circ\text{C/W}$

**Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)****Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	40	---	---	V
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =32V, V <sub>GS</sub> =0V	---	---	1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	---	---	±100	nA

**On Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =30A	---	---	4	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1.0	---	3.0	V

**Dynamic and switching Characteristics (NOTE 4)**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =20V, V <sub>GS</sub> =10V, I <sub>D</sub> =40A	---	71	---	nC
Q <sub>gs</sub>	Gate-Source Charge		---	14	---	
Q <sub>gd</sub>	Gate-Drain Charge		---	13	---	
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =20V, V <sub>GS</sub> =10V, R <sub>G</sub> =3Ω, I <sub>D</sub> =40A	---	15	---	nS
T <sub>r</sub>	Rise Time		---	60	---	
T <sub>d(off)</sub>	Turn-Off Delay Time		---	97	---	
T <sub>f</sub>	Fall Time		---	35.5	---	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V, f=1MHz	---	4150	---	pF
C <sub>oss</sub>	Output Capacitance		---	400	---	
C <sub>rss</sub>	Reverse Transfer Capacitance		---	378	---	
R <sub>g</sub>	Gate Resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz	---	2	---	Ω

**Drain-Source Diode Characteristics and Ratings**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I <sub>S</sub>	Continuous Source Current	V <sub>G</sub> =V <sub>D</sub> =0V, Force Current	---	---	85	A
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V, I <sub>S</sub> =1A	---	---	1	V

**NOTES :**

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V<sub>DD</sub>=25V, V<sub>GS</sub>=10V, L=1mH, I<sub>AS</sub>=20A.
3. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%.
4. Guaranteed by design, not subject to production testing.



Characteristics Curves

FIG. 1-Drain Current

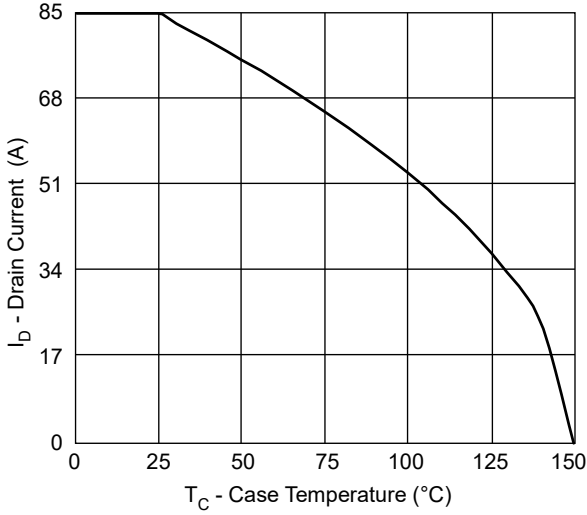


FIG. 2-Normalized  $V_{GS(th)}$  vs  $T_J$

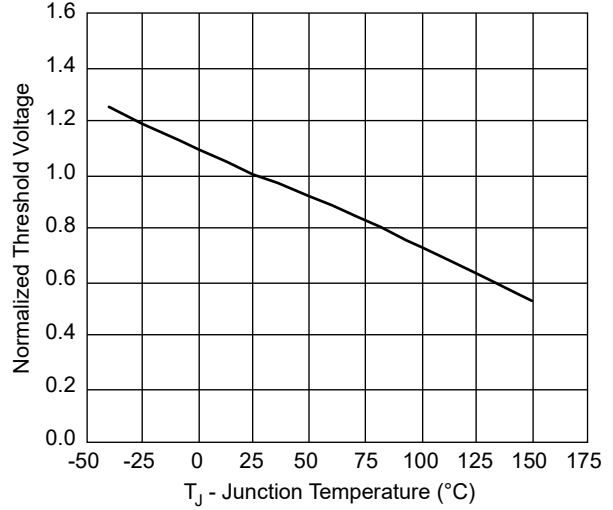


FIG. 2-Normalized  $R_{DS(on)}$  vs  $T_J$

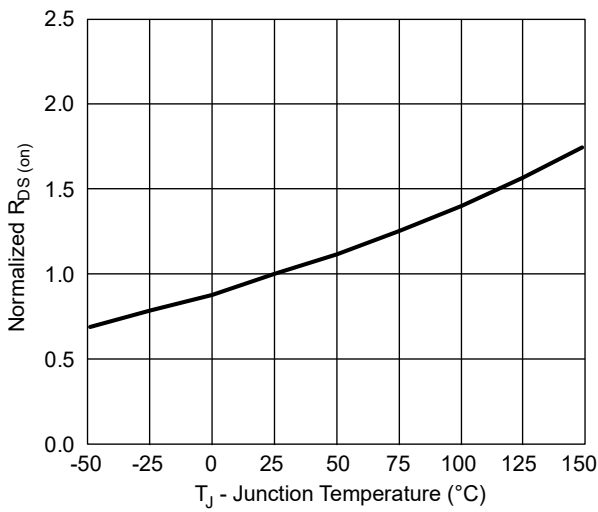


FIG. 4-Gate Charge Characteristics

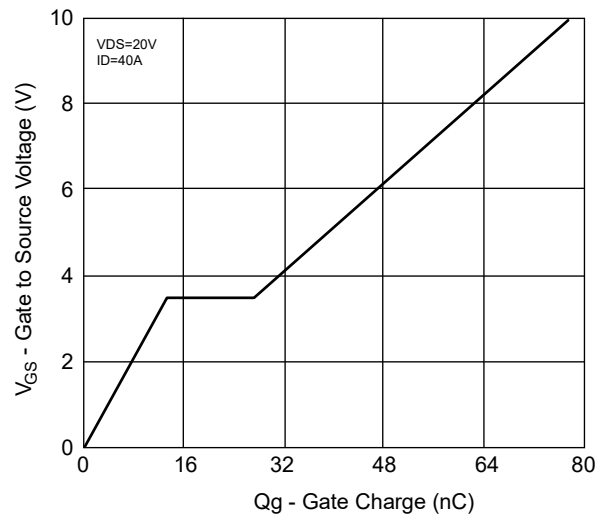


FIG. 5-Safe Operation Area

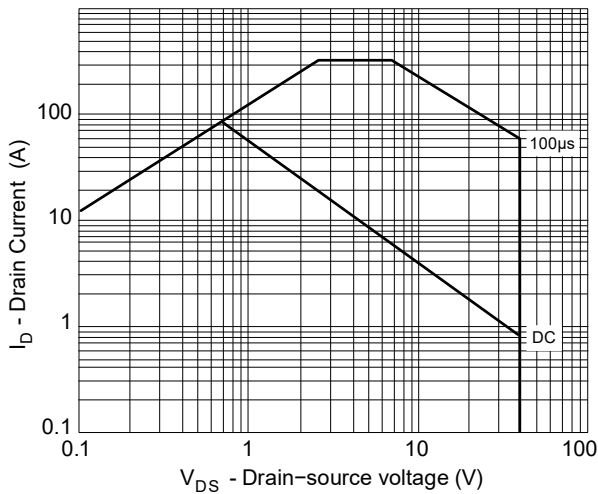
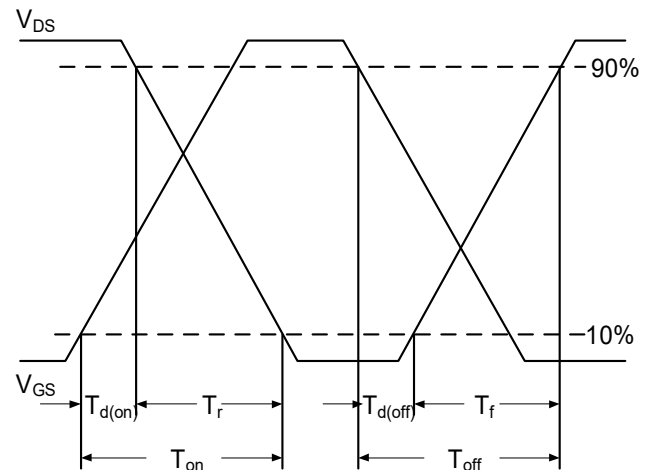
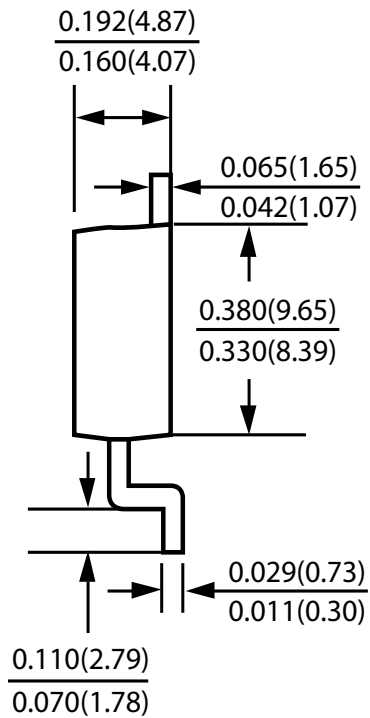
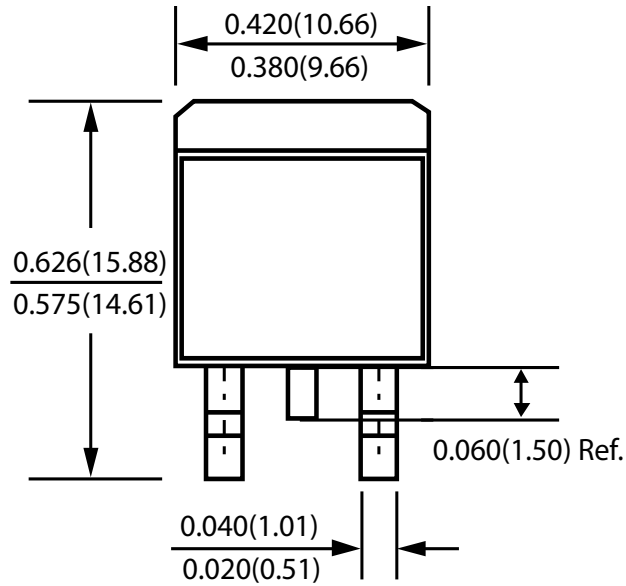


FIG. 6 - Switching Time Waveform





Package Outline Dimensions



TO-263

Dimensions in inches and (millimeters)



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